

Product data sheet

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MAIN APPLICATIONS

USB 2.0&3.0 power and data line protection

Digital video interface (DVI)

- Notebook computers
- Video graphics cards
- Monitors and flat panel displays
- 10/100/1000 ethernet
- SIM ports
- ATM interfaces

PROTECTION SOLUTION TO MEET

IEC61000-4-2 (ESD) ±20kV (air), ±20kV (contact)

IEC61000-4-4 (EFT) 40A (5/50ns)

IEC61000-4-5 (Lightning) 5A (8/20µs)

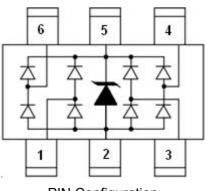
100 watts peak pulse power per line (t_P=8/20µs)

Protects four I/O lines

Low clamping voltage

Low operating voltage

Low capacitance

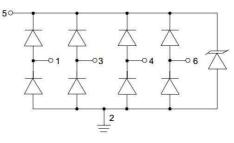


Semiconductor

Compiance

AZC199-04S-MS

PIN Configuration



Circuit Diagram

ABSOLUTE MAXIMUM RATINGS (TA=25°C, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit		
Peak pulse power dissipation on 8/20µs waveform	P _{PP}	100	W		
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	+/- 20 +/-20	kV		
Lead soldering temperature	TL	260 (10 sec.)	°C		
Operating junction temperature range	TJ	-55 to +125	°C		
Storage temperature range	T _{STG}	-55 to +150	°C		

ELECTRICAL CHARACTERISTICS (TA=25°C)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse working voltage	V _{RWM}				5.0	V
Reverse breakdown voltage	V _{BR}	l⊤=1mA	6.0			V
Reverse leakage current	I _R	V _{RWM} =5V			1	μA
Forward voltage	VF	I⊤=10mA		0.8	1.0	V
Clamping voltage (I/O pin to Ground)	Vc	I _{PP} =1A, t _P =8/20µs		9.5	11	V
	Vc	I _{PP} =5A, t _P =8/20µs		12.5	15	
Junction capacitance		V _{RWM} =0V, f=1MHz Any I/O pin to Ground		0.65	0.8	5
	CJ	V _{RWM} =0V, f=1MHz Between I/O pins		0.3	0.5	pF





Electrical Parameter

Symbol	Parameter
Symbol	Farailieter
I _{PP}	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ IPP
V _{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
Ι _Τ	Test Current
V _{BR}	Breakdown Voltage @ I⊤

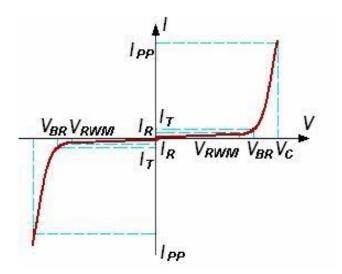
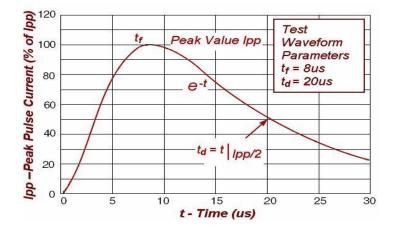
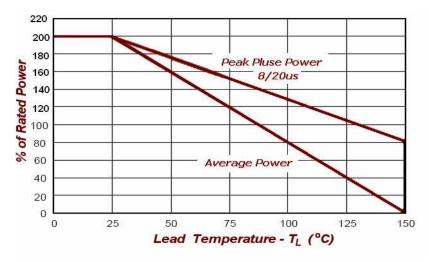


FIG1: Pulse Waveform



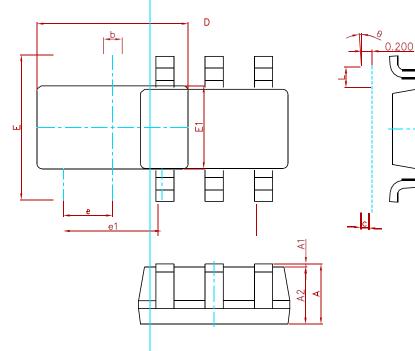






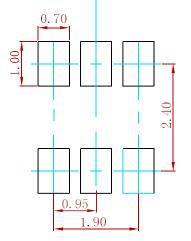


PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E1	1.500	1.700	0.059	0.067	
E	2.650	2.950	0.104	0.116	
е	0.950(BSC)		0.037(BSC)		
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

Suggested Pad Layout



Note:

Controlling dimension:in millimeters.
General tolerance:±0.05mm.
The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N PKG QTY	
AZC199-04S-MS SOT-23-6 3000	





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